


PCN Number:	20230822001.0		PCN Date:	August 24, 2023												
Title:	Datasheet for BQ25504															
Customer Contact:	Change Management team	Dept:	Quality Services													
Change Type:	Electrical Specification															
PCN Details																
Description of Change:																
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.</p> <div style="display: flex; justify-content: space-between; align-items: center;">  <div style="text-align: right;"> BQ25504 <small>SLUSAH0G – OCTOBER 2011 – REVISED AUGUST 2023</small> </div> </div> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="text-align: left;">Changes from Revision F (November 2019) to Revision G (August 2023)</th> <th style="text-align: right;">Page</th> </tr> </thead> <tbody> <tr> <td>• Added "Connect to thermal pad." to AVSS and VSS pin descriptions in <i>Pin Functions</i> table.....</td> <td style="text-align: right;">5</td> </tr> <tr> <td>• Added lines from AVSS and VSS to GND in <i>Figure 11-1</i></td> <td style="text-align: right;">29</td> </tr> </tbody> </table> <p>The datasheet number will be changing.</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 33%;">Device Family</td> <td style="width: 33%;">Change From:</td> <td style="width: 33%;">Change To:</td> </tr> <tr> <td>BQ25504</td> <td>SLUSAH0F</td> <td>SLUSAH0G</td> </tr> </table> <p>These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/BQ25504</p>					Changes from Revision F (November 2019) to Revision G (August 2023)	Page	• Added "Connect to thermal pad." to AVSS and VSS pin descriptions in <i>Pin Functions</i> table.....	5	• Added lines from AVSS and VSS to GND in <i>Figure 11-1</i>	29	Device Family	Change From:	Change To:	BQ25504	SLUSAH0F	SLUSAH0G
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Device Family	Change From:	Change To:														
BQ25504	SLUSAH0F	SLUSAH0G														
Reason for Change:																
To accurately reflect device characteristics.																
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):																
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device																
Changes to product identification resulting from this PCN:																
None.																
Product Affected:																
BQ25504RGTR	BQ25504RGTT															

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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